AON6411

20V P-Channel MOSFET

General Description

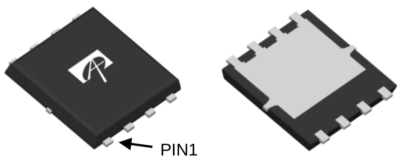
The AON6411 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

Product Summary

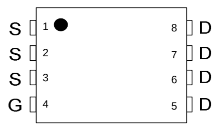
V_{DS}	-20
I_D (at V_{GS}= -10V)	-85A
$R_{DS(ON)}$ (at V_{GS}= -10V)	< 2.1mΩ
$R_{DS(ON)}$ (at V_{GS} =-4.5V)	< 2.5mΩ
$R_{DS(ON)}$ (at V_{GS} =-2.5V)	< 3.6mΩ

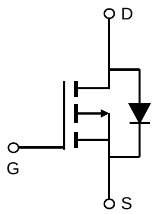
100% UIS Tested
100% R_g Tested

DFN5X6



Top View





Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current [G]	T_C=25℃	I_D	-85	A
	T_C=100℃		-67	
Pulsed Drain Current [C]		I_{DM}	-340	
Continuous Drain Current	T_A=25℃	I_{DSM}	-47	A
	T_A=70℃		-38	
Avalanche Current [C]		I_{AS}	70	A
Avalanche energy L=0.1mH [C]		E_{AS}	245	mJ
Power Dissipation [B]	T_C=25℃	P_D	156	W
	T_C=100℃		62.5	
Power Dissipation [A]	T_A=25℃	P_{DSM}	7.3	W
	T_A=70℃		4.7	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	℃

Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	14	17	℃/W
Maximum Junction-to-Ambient [A D]	Steady-State		40	55	℃/W
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	0.6	0.8	℃/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
STATIC PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=-250µA, V_{GS}=0V		-20			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=-20V, V_{GS}=0V				-1	µA
			T_J=55°C			-5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±12V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250µA		-0.5	-0.85	-1.3	V
$I_{D(ON)}$	On state drain current	V_{GS}=-10V, V_{DS}=-5V		-340			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-10V, I_D=-20A			1.7	2.1	mΩ
			T_J=125°C		2.45	3	
		V_{GS}=-4.5V, I_D=-20A			2	2.5	mΩ
		V_{GS}=-2.5V, I_D=-20A			2.8	3.6	mΩ
g_{FS}	Forward Transconductance	V_{DS}=-5V, I_D=-20A			115		S
V_{SD}	Diode Forward Voltage	I_S=-1A, V_{GS}=0V			-0.57	-1	V
I_S	Maximum Body-Diode Continuous Current [G]					-85	A
DYNAMIC PARAMETERS							
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=-10V, f=1MHz			10290		pF
C_{oss}	Output Capacitance				1910		pF
C_{rss}	Reverse Transfer Capacitance				1395		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz			2.1	4.2	Ω
SWITCHING PARAMETERS							
Q_g(10V)	Total Gate Charge	V_{GS}=-10V, V_{DS}=-10V, I_D=-20A			235	330	nC
Q_g(4.5V)	Total Gate Charge				100	140	nC
Q_{gs}	Gate Source Charge				21		nC
Q_{gd}	Gate Drain Charge				36		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=-10V, V_{DS}=-10V, R_L=0.5Ω, R_{GEN}=3Ω			9		ns
t_r	Turn-On Rise Time				18		ns
$t_{D(off)}$	Turn-Off DelayTime				282		ns
t_f	Turn-Off Fall Time				90		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=-20A, dI/dt=500A/µs			48		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=-20A, dI/dt=500A/µs			178		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The Power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design, and the maximum temperature of 150°C may be used if the PCB allows it.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J =25°C. Maximum UIS current limited by test equipment.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=150°C. The SOA curve provides a single pulse rating.
G. The maximum current rating is package limited.
H. These tests are performed with the device mounted on 1 in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

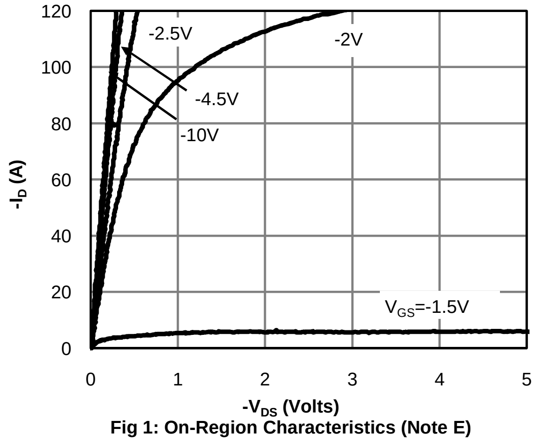


Fig 1: On-Region Characteristics (Note E)

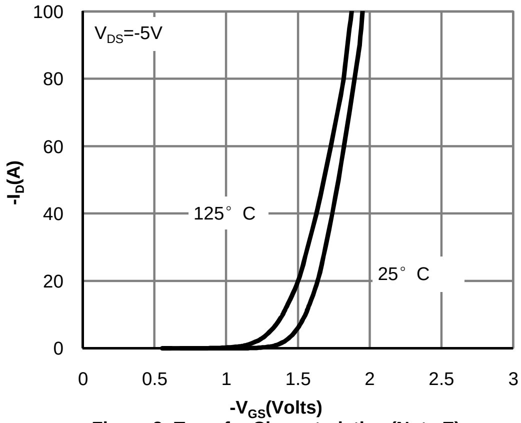


Figure 2: Transfer Characteristics (Note E)

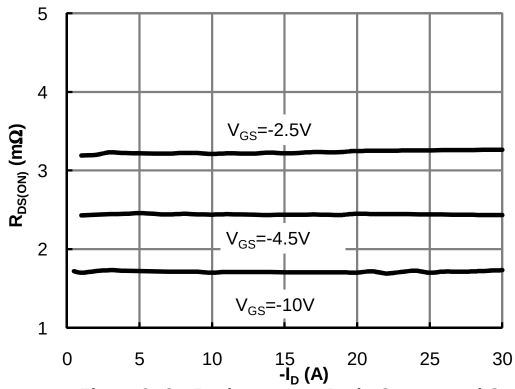


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

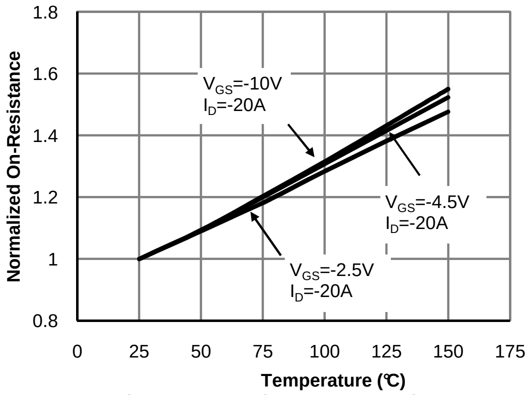


Figure 4: On-Resistance vs. Junction Temperature (Note E)

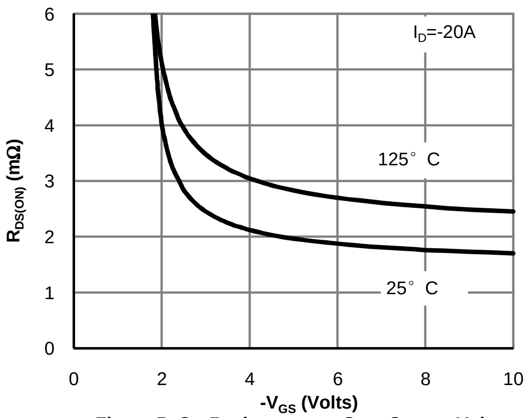


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

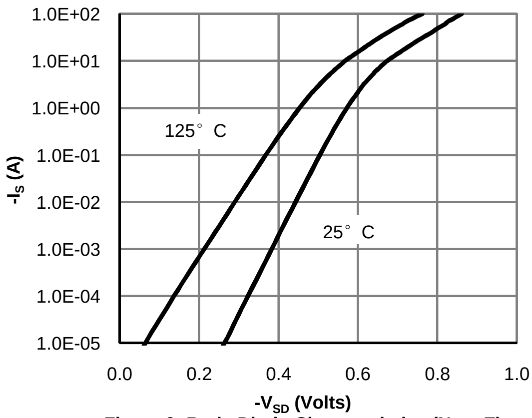


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

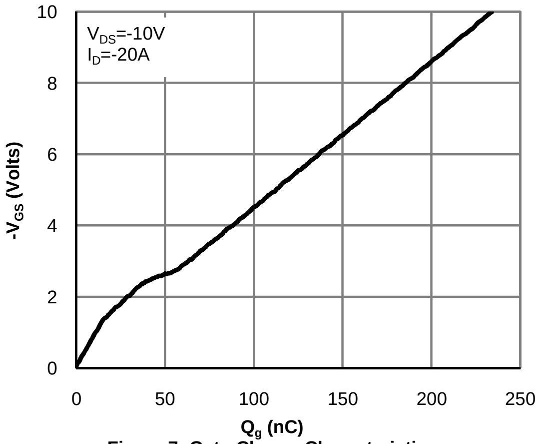


Figure 7: Gate-Charge Characteristics

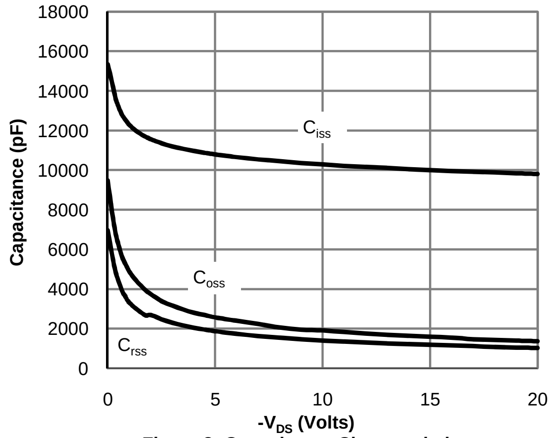


Figure 8: Capacitance Characteristics

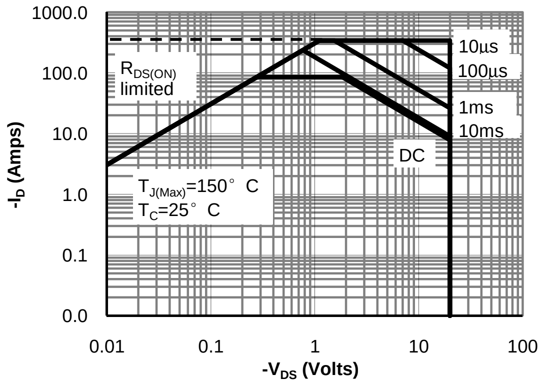


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

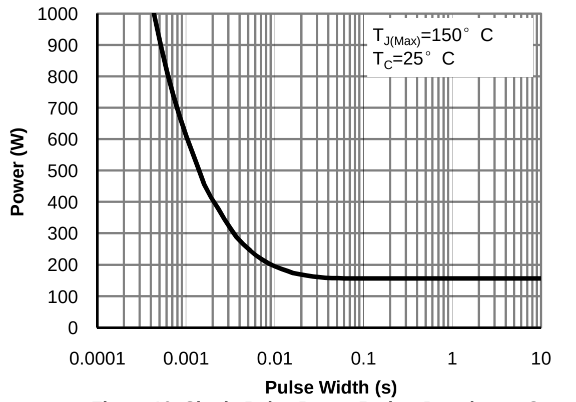


Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

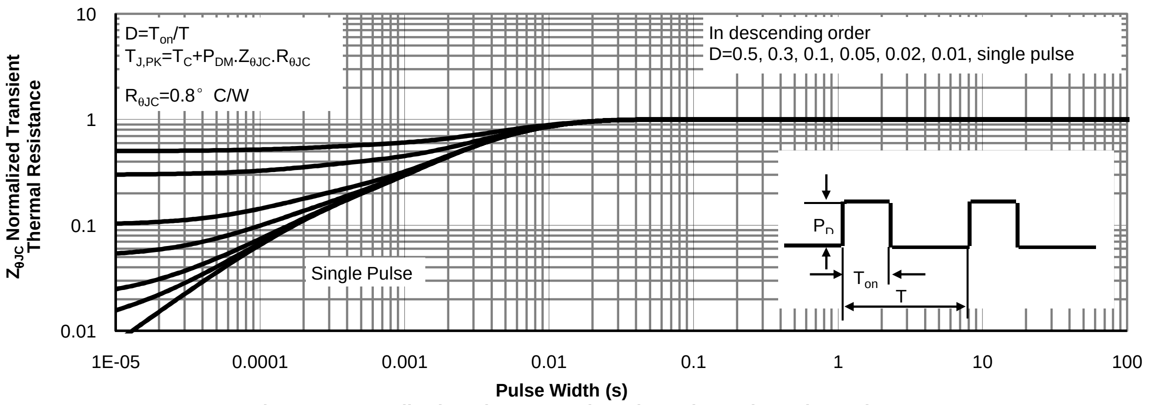


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

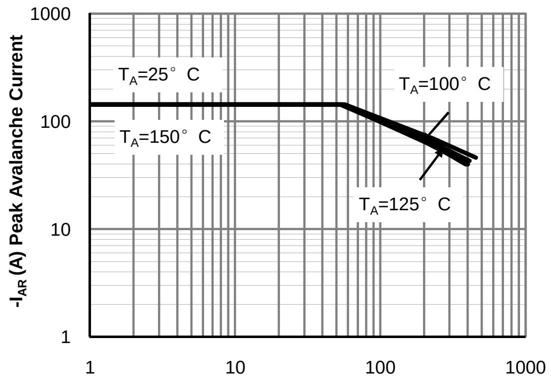


Figure 12: Single Pulse Avalanche capability (Note C)

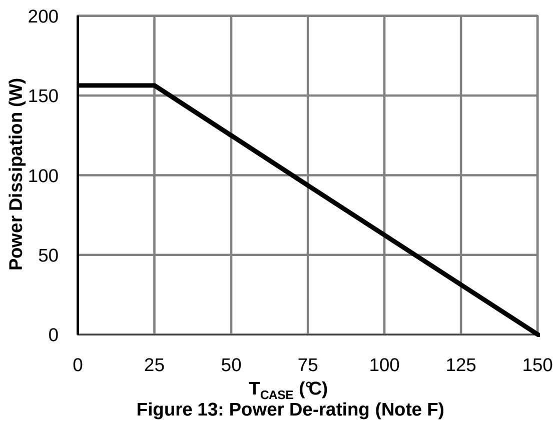


Figure 13: Power De-rating (Note F)

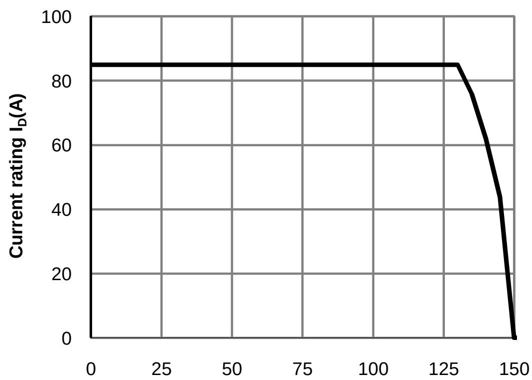


Figure 14: Current De-rating (Note F)

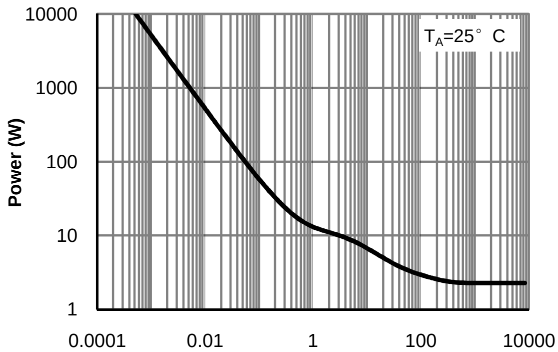


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

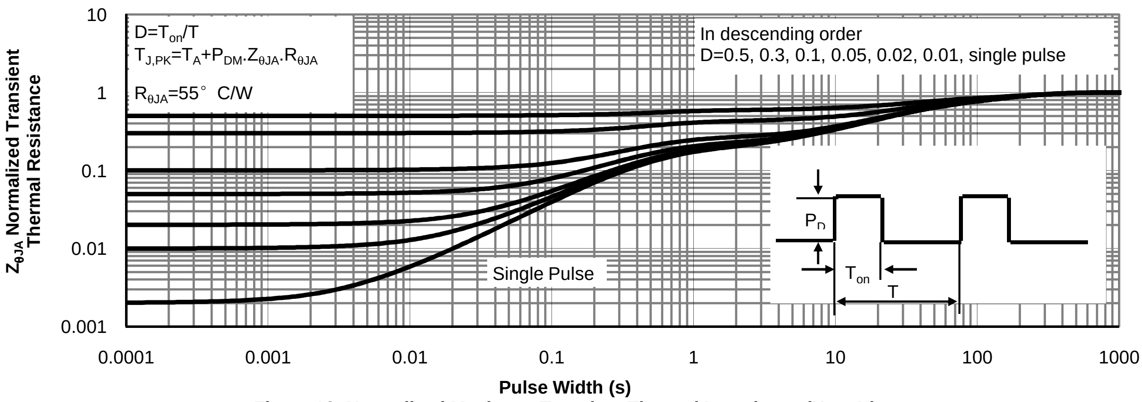
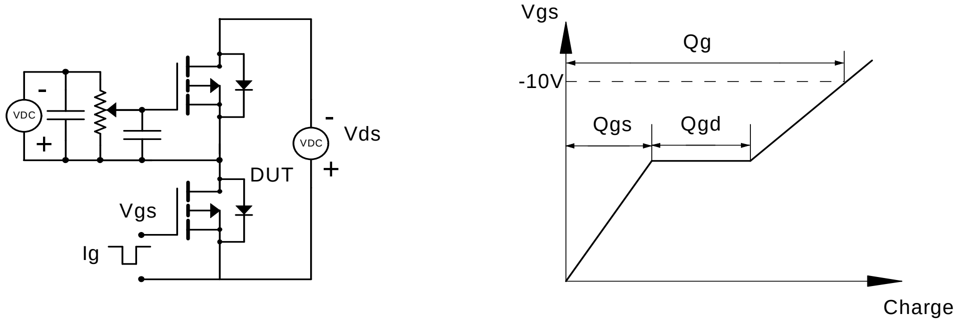
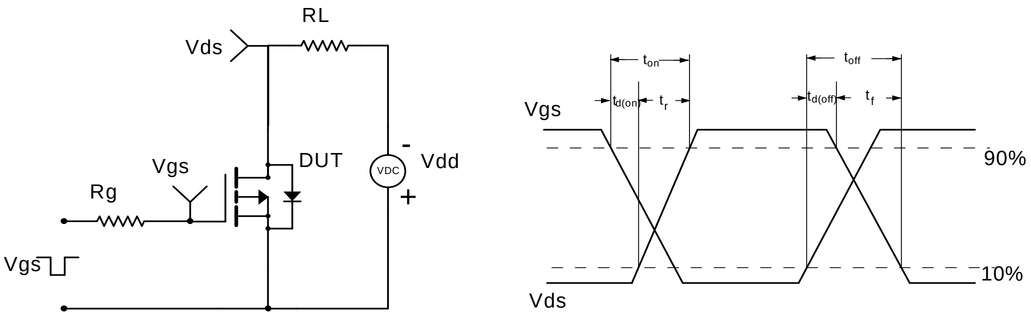


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

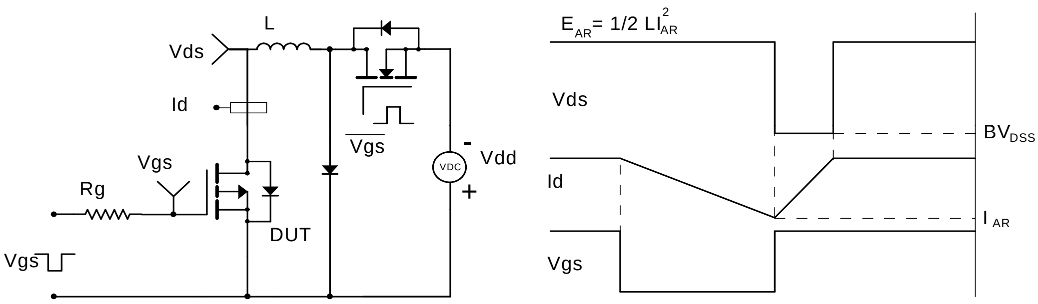
Gate Charge Test Circuit & Waveform



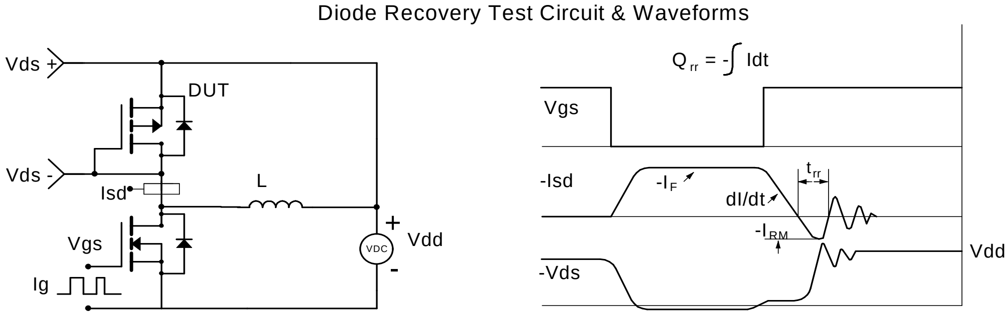
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



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